

16-BIT 2:1 MUX/DEMUX SWITCH

IDT74FST163233 ADVANCE INFORMATION

FEATURES:

- · Bus switches provide zero delay paths
- Extended commercial range of -40°C to +85°C
- Low switch on-resistance: FST163xxx 7Ω
- · TTL-compatible input and output levels
- ESD > 2000V per MIL-STD-883, Method 3015;
 > 200V using machine model (C = 200pF, R = 0)
- Available in SSOP, TSSOP and TVSOP

DESCRIPTION:

The FST163233 belongs to IDT's family of Bus switches. Bus switch devices perform the function of connecting or isolating two ports without providing any inherent current sink or source capability. Thus they generate little or no noise of

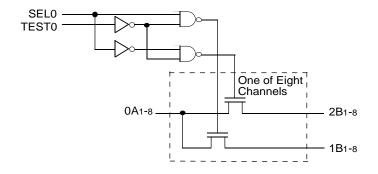
their own while providing a low resistance path for an external driver. These devices connect input and output ports through an n-channel FET. When the gate-to-source junction of this FET is adequately forward-biased the device conducts and the resistance between input and output ports is small. Without adequate bias on the gate-to-source junction of the FET, the FET is turned off, therefore with no Vcc applied, the device has hot insertion capability.

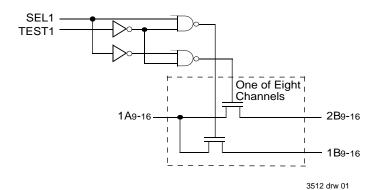
The low on-resistance and simplicity of the connection between input and output ports reduces the delay in this path to close to zero.

The FST163233 provides three 16-bit TTL-compatible ports that support 2:1 multiplexing. The SEL0,1 and TEST0,1 pins provide switch enable and mux select control as shown below.

The A port can be connected to port 1B or port 2B or both ports 1B and 2B.

FUNCTIONAL BLOCK DIAGRAM





PIN DESCRIPTION

Pin Names	I/O	Description
A, 1B, 2B	I/O	Buses A, 1B, 2B
SEL0-1,	I	Control Pins for Mux and Switch
TEST ₀₋₁		Enable Functions

3512 tbl 01

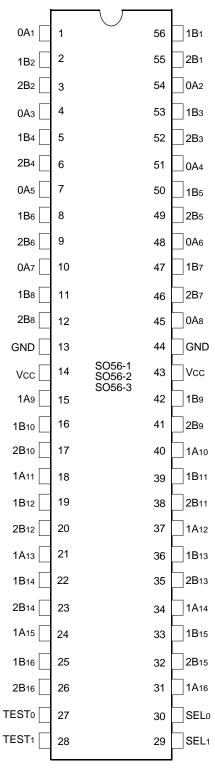
The IDT logo is a registered trademark of Integrated Device Technology, Inc.

COMMERCIAL TEMPERATURE RANGE

AUGUST 1996

DSC-3512/1

PIN CONFIGURATION



SSOP/ TSSOP/TVSOP TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max.	Unit
VTERM(2)	Terminal Voltage with Respect to GND	-0.5 to +7.0	V
Tstg	Storage Temperature	-65 to +150	°C
Іоит	Maximum Continuous Channel Current	128	mA

NOTES:

3512 tbl 02

- Stresses greater than those listed under ABSOLUTE MAXIMUM RAT-INGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating condiitions for extended periods may affect reliability.
- 2. Vcc, Control and Switch terminals.

CAPACITANCE⁽¹⁾

Symbol	Parameter	Conditions(2)	Тур.	Unit
CIN	Control Input Capacitance		4	pF
CI/O	Switch Input/Output Capacitance	Switch Off		pF

NOTES:

3512 tbl 03

- 1. Capacitance is characterized but not tested
- 2. TA = 25°C, f = 1MHz, VIN = 0V, VOUT = 0V

FUNCTION TABLE

SEL ₀	TEST ₀	Function
L	L	0A to 1B
Н	L	0A to 2B
Х	Н	0A to 1B and 0A to 2B
SEL1	TECT.	Fetien
SEL1	TEST ₁	Function
L	L L	1A to 1B
L H	L L	

3512 tbl 04

3512 drw 02

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Commercial: TA = -40° C to $+85^{\circ}$ C, Vcc = 5.0V $\pm 10\%$

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
VIH	Input HIGH Voltage	Guaranteed Logic HIGH for Control Inputs		2.0	_		V
VIL	Input LOW Voltage	Guaranteed Logic LOW for Co	ontrol Inputs	1	_	0.8	V
lтн	Input HIGH Current	Vcc = Max.	VI = VCC	_	_	±1	μΑ
liL	Input LOW Voltage		VI = GND	_	_	±1	
lozн	High Impedance Output Current	Vcc = Max.	Vo = Vcc	_	_	±1	μΑ
lozL	(3-State Output pins)		Vo = GND	_	_	±1	
los	Short Circuit Current	Vcc = Max., Vo = GND ⁽³⁾		_	300	_	mA
Vik	Clamp Diode Voltage	Vcc = Min., IIN = -18mA		_	-0.7	-1.2	V
Ron	Switch On Resistance ⁽⁴⁾	VCC = Min., VIN = 0.0V		_	5	7	Ω
		Ion = 12mA					
		VCC = Min., VIN = 2.4V		_	10	15	Ω
		Ion = 8mA					
IOFF	Input/Output Power Off Leakage	$VCC = 0V$, $VIN or VO \le 4.5V$			_	±1	μΑ
Icc	Quiescent Power Supply Current	Vcc = Max., Vin = GND or Vcc		_	0.1	3	μΑ

NOTES:

3512 tbl 05

^{1.} For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.

^{2.} Typical values are at Vcc = 5.0V, +25°C ambient.

^{3.} Not more than one output should be tested at one time. Duration of the test should not exceed one second.

^{4.} Measured by voltage drop between ports at indicated current through the switch.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
Δlcc	Quiescent Power Supply Current TTL Inputs HIGH	VCC = Max. $VIN = 3.4V^{(3)}$		_	0.5	1.5	mA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = Max. Outputs Open Enable Pin Toggling 50% Duty Cycle VIN = Vcc VIN = GND		_	30	40	μΑ/ MHz/ Switch
lc	Total Power Supply Current ⁽⁶⁾	Vcc = Max. Outputs Open 2 Select Pins Toggling	VIN = VCC VIN = GND	_	4.8	6.4	mA
		(16 Switches Toggling) fi = 10MHz 50% Duty Cycle	VIN = 3.4 VIN = GND	_	5.3	7.9	

NOTES:

3512 tbl 06

- 1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Per TTL driven input (VIN = 3.4V). All other inputs at Vcc or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- 5. Values for these conditions are examples of the lcc formula. These limits are guaranteed but not tested.
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC

 $Ic = Icc + \Delta Icc DhNt + Icco (fiN)$

Icc = Quiescent Current

 Δ Icc = Power Supply Current for a TTL High Input (ViN = 3.4V)

DH = Duty Cycle for TTL Inputs High

NT = Number of TTL Inputs at DH

ICCD = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

fi = Input Frequency

N = Number of Switches Toggling at fi

All currents are in milliamps and all frequencies are in megahertz.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Commercial: TA = -40°C to +85°C, VCC = 5.0V ± 10 %

Symbol	Description	Condition ⁽¹⁾	Min. ⁽²⁾	Тур.	Max.	Unit
tPLH	Data Propagation Delay	CL = 50pF	_	_	0.25	ns
tPHL	A to B, B to A ^(3,4)	$RL = 500\Omega$				
tBX	Switch Multiplex Delay		1.5	_	6.5	ns
	SEL to A					
tPZH	Switch Turn on Delay		1.5	_	6.5	ns
tPZL	SEL, TEST to B					
tPHZ	Switch Turn off Delay		1.5	_	7	ns
tPLZ	SEL, TEST to B					
Qcı	Charge Injection, Typical ^(5,7)			1.5		рС
QDCI	Charge Injection, Typical ^(6,7)			0.5	_	

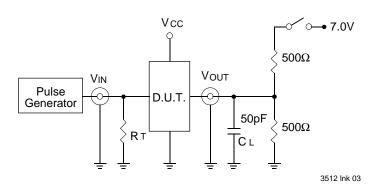
NOTES:

3512 tbl 07

- 1. See test circuit and waveforms.
- 2. Minimum limits guaranteed but not tested.
- 3. This parameter is guaranteed by design but not tested.
- 4. The bus switch contributes no propagation delay other than the RC delay of the on resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 2.5ns for 50pF load. Since this time is constant and much smaller than the rise/fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay on the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.
- 5. Measured at switch turn off, load = 50 pF in parallel with 10 M Ω scope probe, ViN = 0.0 volts.
- 6. Measured at switch turn off through bus multiplexer, (e.g.- A to 1B = >A to 2B), load = 50 pF in parallel with 10 MΩ scope probe, V_{IN} at A = 0.0 volts. Charge injection is reduced because the injection from the turn off of the A to 1B switch is compensated by the turn on of the A to 2B switch.
- 7. Characterized parameter. Not 100% tested.

3512 lnk 08

TEST CIRCUITS AND WAVEFORMS TEST CIRCUITS FOR ALL OUTPUTS



SWITCH POSITION

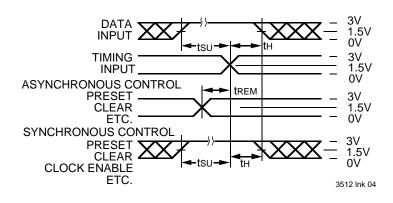
Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

DEFINITIONS:

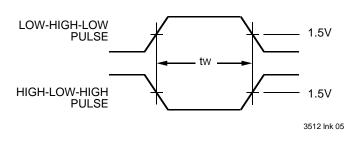
C_L= Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to Zout of the Pulse Generator.

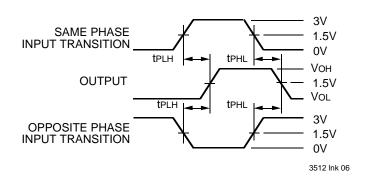
SET-UP, HOLD AND RELEASE TIMES



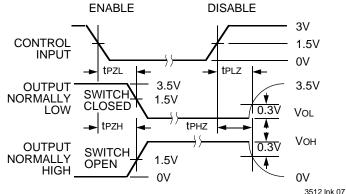
PULSE WIDTH



PROPAGATION DELAY



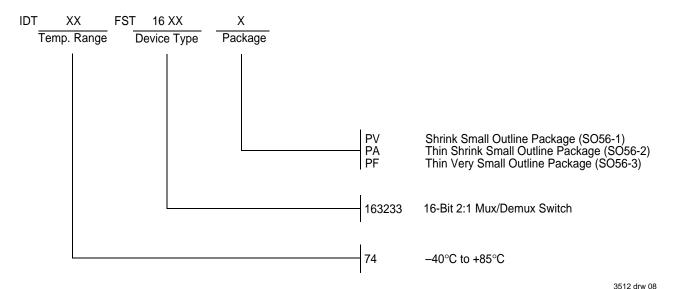
ENABLE AND DISABLE TIMES



NOTES:

- Diagram shown for input Control Enable-LOW and input Control Disable-HIGH
- 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2.5ns; tR \leq 2.5ns

ORDERING INFORMATION



Integrated Device Technology, Inc. reserves the right to make changes to the specifications in this data sheet in order to improve design or performance and to supply the best possible product.

Integrated Device Technology, Inc.

2975 Stender Way, Santa Clara, CA 95054-3090

Telephone: (408) 727-6116

FAX 408-492-8674